



Discontinuation Notification

202108003DN : TBGA Package Only Discontinuance for
MPC8280/8270, MPC8360/8358, MPC8347/8349 Families

Note: This notice is NXP Company
Proprietary.

Issue Date: Sep 02, 2021 **Effective date:** Sep 03, 2021

PCN Overview

Discontinuation Information

This limited discontinuance is driven by our supplier EOL of specific TBGA substrates. Due to limited capacity, NXP can not guarantee that all orders will be fulfilled.

Last time buy date is December 1, 2021.

Last time delivery date will be December 1, 2023.

This Discontinuation Notice confirms to your company that NXP Semiconductors (NXP) is now discontinuing the manufacture of a number of its integrated circuits and discrete semiconductors listed in the Part Type Affected list included with this notification. In accordance with NXP product discontinuation policy and JEDEC EIA/JESD48, we are hereby giving notice of these product changes so that our customers and partners can adjust their product purchasing records, or make any final lifetime purchases of the discontinued products that can still be supplied by NXP.

While this Discontinuation Notice contains a number of NXP discontinued end-of-life Product Types, the Part Types Affected (PTA) list represents a small percentage of NXP overall semi-conductors product portfolio. Some of these discontinued products have had little to no recent sales history or they are at the end-of-life (EOL) stage. The PTA list may also cover a number of versions or selections of the same basic Product Type.

We regret the inconvenience and impact this notice may cause. NXP Semiconductors' sales, marketing and distribution personnel stand ready to assist you in placing our customers and partners' final orders, or in providing product information you require. On behalf of NXP Semiconductors, we appreciate your understanding and assistance in helping us to help you minimize the impact of this product discontinuation on your company. We look forward to NXP Semiconductors' continued support of your company's semiconductor requirements in the years to come.

Reason for Discontinuance

TBGA substrate supplier discontinuing these unique TBGA packages.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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